

Rev.	Description	Date	Drawn	Checked
A	INITIAL RELEASE	2016.11.01	SWC	
B	UPDATE	2016.12.01	SWC	

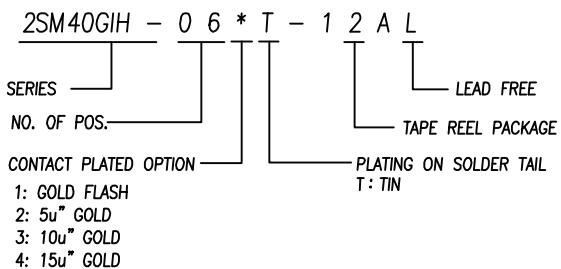
MATERIALS


HOUSING: HI-TEMP, THERMOPLASTIC, LCP, UL 94V-0, BLACK
 TERMINAL: PHOSPHOR BRONZE ,C5191, 0.8u" GOLD PLATED CONTACT AREA
 80u" MIN TIN PLATED SOLDER AREA
 50u" MIN NICKEL UNDER PLATED OVER ALL
 SHELL: STAINLESS STEEL, SUS304, 30u" MIN NICKEL PLATED OVER ALL.
 0.5u: GOLD PLATED ON SOLDER TAILS
 COIL :SWP
 CAM ROD: STAINLESS STEEL, 30u" MIN NICKEL PLATED OVER ALL.
 0.5u" GOLD PLATED ON SOLDER TAILS

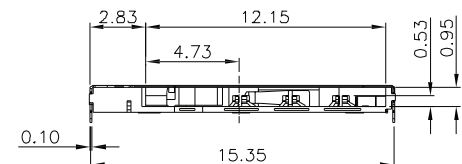
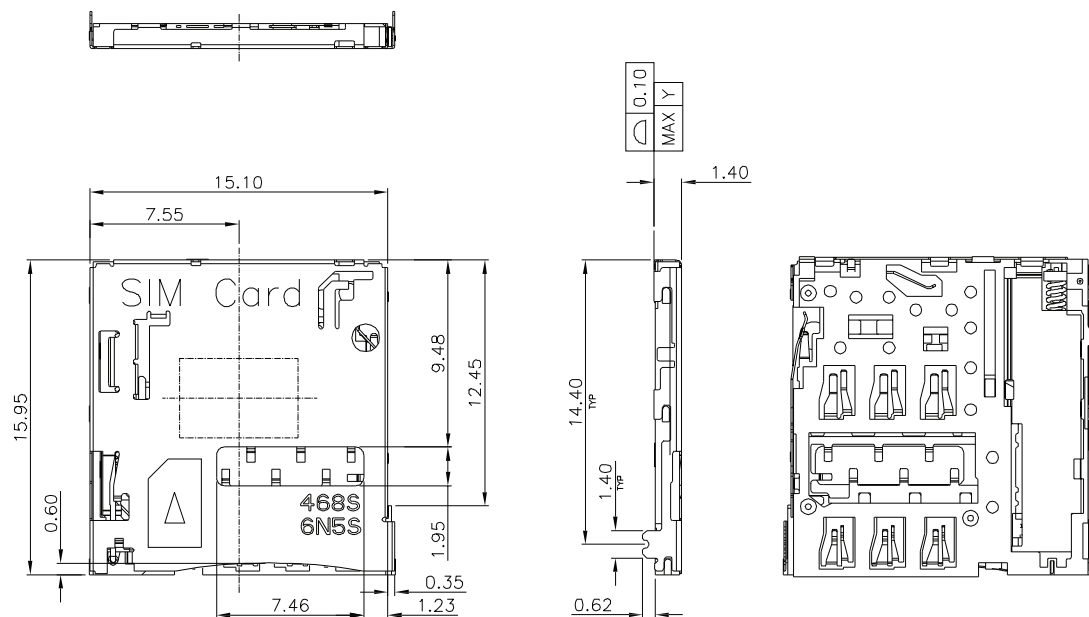
SPECIFICATION

CURRENT RATING: 1 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 100m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 250V
 OPERATION TEMPERATURE: -25°C~+85°C

PART NUMBER



UNLESS OTHERWISE SPECIFIED TOLERANCES		 Singatron Enterprise Co., Ltd. 信音企業股份有限公司	
DECIMALS: ANGLES:		TITLE	
X : ±0.5	X : ±2°	MICRO SIM CARD, 6 PIN, DIP+SMT, METAL SHIELD, FEMALE, P-P TYPE ,H=1.35 mm	
X.X : ±0.35	X.X : ±1°	DWN	SWC 2016.12.01 PART NO. 2SM40GIH-06XT-12AL
X.XX : ±0.25		CHKD	SCALE 1:1 UNIT: mm
		APVD	SIZE: A3 SHEET: 1 OF 3 REV: B
CUSTOMER COPY			



THERE IS NO MICRO SIM CARD LOCK IN THIS CONNECTOR.
 CARD STOPPER AS SHOWN BELOW MUST BE NECESSARY.

